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On-chip repair and an ATE independent fusing methodology

Cowan, B. Farnsworth, O. Jakobsen, P. Oakland, S. Ouellette, M.R. Wheater, D.I IBM, Essex Junction, VT, USA

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Abstract:

This paper describes a novel on chip repair system designed for ATE independ application on many unique very dense ASIC devices in a high turnover envire During test, the system controls on chip built-in self-test (BIST) engines, colle compresses repair data, programs fuses and finally decompresses and reloads data for post fuse testing. In end use applications this system decompresses : the repair data at power-up or at the request of the system.

Index Terms:

application specific integrated circuits automatic test equipment built-in self test elect integrated circuit testing maintenance engineering ASIC on-chip repairs ATE indeper methodology BIST built-in self-test engines e-fuse programming electrically program high turnover environment on chip repair systems post fuse testing repair data collection/compression repair data decompression/reloading unique very dense ASIC

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